



**Is Now Part of**



**ON Semiconductor®**

**To learn more about ON Semiconductor, please visit our website at**  
**[www.onsemi.com](http://www.onsemi.com)**

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at [www.onsemi.com](http://www.onsemi.com). Please email any questions regarding the system integration to [Fairchild\\_questions@onsemi.com](mailto:Fairchild_questions@onsemi.com).

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.



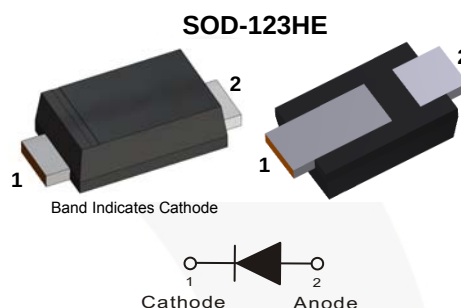
February 2017

## SS12FP - S115FP

### 1 A, 20 V - 150 V Surface Mount Schottky Barrier Rectifiers

#### Features

- Larger Cathode Pad for Improved Power Dissipation
  - Ultra Thin Profile - Package Height < 1.0 mm
  - High Surge Current Capability
  - Low Power Loss, High Efficiency
  - UL Flammability 94V-0 Classification
  - MSL 1 per J-STD-020
  - RoHS Compliant / Green Molding Compound
  - Industrial Device Qualified per AEC-Q101 Standards
- \* See authorized use policy



#### Ordering Information

| Part Number | Top Mark | Package   | Packing Method |
|-------------|----------|-----------|----------------|
| SS12FP      | 2FP      | SOD-123HE | Tape and Reel  |
| SS13FP      | 3FP      | SOD-123HE | Tape and Reel  |
| SS14FP      | 4FP      | SOD-123HE | Tape and Reel  |
| SS16FP      | 6FP      | SOD-123HE | Tape and Reel  |
| S110FP      | 0FP      | SOD-123HE | Tape and Reel  |
| S115FP      | AFP      | SOD-123HE | Tape and Reel  |

SS12FP - S115FP — 1 A, 20 V - 150 V Surface Mount Schottky Barrier Rectifiers

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

| Symbol             | Parameter                                                                           | Value       |            |             |            |            |            | Unit |
|--------------------|-------------------------------------------------------------------------------------|-------------|------------|-------------|------------|------------|------------|------|
|                    |                                                                                     | SS12<br>FP  | SS13<br>FP | SS14<br>FP  | SS16<br>FP | S110<br>FP | S115<br>FP |      |
| V <sub>RRM</sub>   | Repetitive Peak Reverse Voltage                                                     | 20          | 30         | 40          | 60         | 100        | 150        | V    |
| V <sub>RMS</sub>   | RMS Reverse Voltage                                                                 | 14          | 21         | 28          | 42         | 70         | 105        | V    |
| V <sub>R</sub>     | DC Blocking Voltage                                                                 | 20          | 30         | 40          | 60         | 100        | 150        | V    |
| I <sub>F(AV)</sub> | Average Forward Rectified Current                                                   | 1           |            |             |            |            |            | A    |
| I <sub>FSM</sub>   | Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load | 30          |            |             |            |            |            | A    |
| T <sub>J</sub>     | Operating Junction Temperature Range                                                | -55 to +125 |            | -55 to +150 |            |            |            | °C   |
| T <sub>STG</sub>   | Storage Temperature Range                                                           | -55 to +150 |            |             |            |            |            | °C   |

## Thermal Characteristics<sup>(1)</sup>

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

| Symbol          | Parameter                                                | Value | Unit                      |
|-----------------|----------------------------------------------------------|-------|---------------------------|
| $\Psi_{JL}$     | Thermal Characteristics, Junction-to-Lead <sup>(2)</sup> | 10    | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient                  | 140   | $^\circ\text{C}/\text{W}$ |

### Notes:

- Per JESD51-3 recommended thermal test board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.
- Thermocouple soldered at cathode lead.

## Electrical Characteristics

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

| Symbol          | Parameter                                               | Condi-<br>tions                                                              | Value      |            |            |            |            |            | Unit |
|-----------------|---------------------------------------------------------|------------------------------------------------------------------------------|------------|------------|------------|------------|------------|------------|------|
|                 |                                                         |                                                                              | SS12<br>FP | SS13<br>FP | SS14<br>FP | SS16<br>FP | S110<br>FP | S115<br>FP |      |
| V <sub>F</sub>  | Maximum Instantaneous<br>Forward Voltage <sup>(3)</sup> | I <sub>F</sub> = 0.5 A                                                       |            |            | 0.51       | 0.58       | 0.70       | 0.75       | V    |
|                 |                                                         | I <sub>F</sub> = 1.0 A                                                       | 0.45       | 0.50       | 0.55       | 0.70       | 0.80       | 0.90       |      |
| I <sub>R</sub>  | Maximum Reverse Current<br>at Rated V <sub>R</sub>      | T <sub>J</sub> = 25°C                                                        | 0.40       |            |            |            | 0.05       |            | mA   |
|                 |                                                         | T <sub>J</sub> = 125°C                                                       |            |            |            |            | 0.50       |            |      |
| C <sub>J</sub>  | Typical Junction Capacitance                            | V <sub>R</sub> = 4 V,<br>f = 1 MHz                                           | 54         |            |            |            | 28         |            | pF   |
| T <sub>rr</sub> | Typical Reverse Recovery<br>Time                        | I <sub>F</sub> = 0.5 A,<br>I <sub>R</sub> = 1 A,<br>I <sub>RR</sub> = 0.25 A | 6          |            |            |            | 14         |            | ns   |

### Note:

- Pulse test with  $PW = 300\text{ }\mu\text{s}$ , 1% duty cycle

## Typical Performance Characteristics

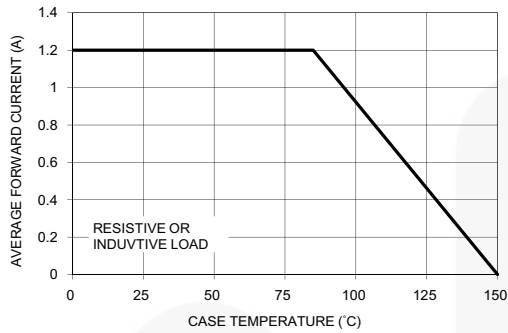


Figure 1. Forward Current Derating Curve

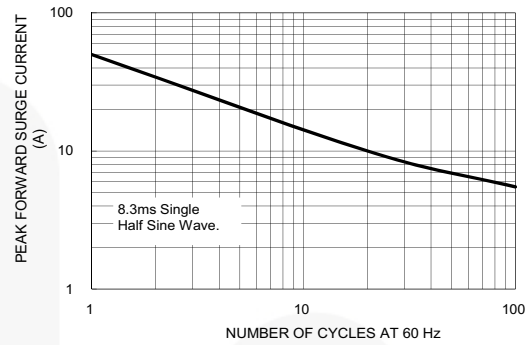


Figure 2. Maximum Non-Repetitive Forward Surge Current

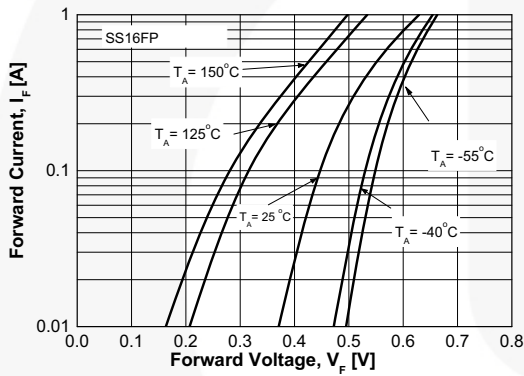


Figure 3. Typical Forward Characteristics

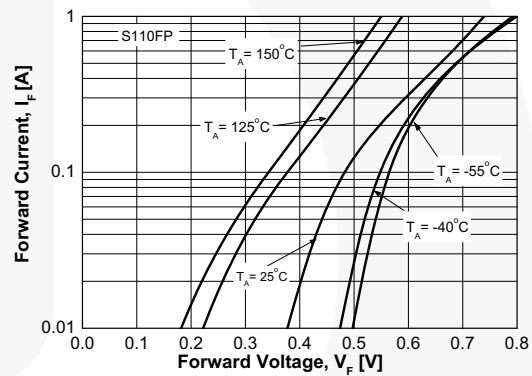


Figure 4. Typical Forward Characteristics

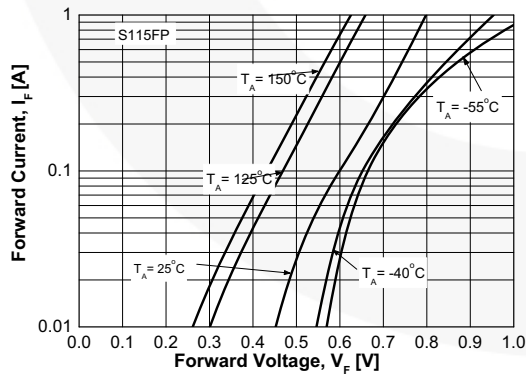


Figure 5. Typical Forward Characteristics

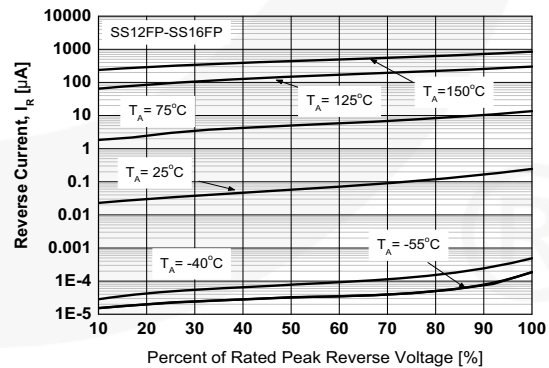


Figure 6. Typical Reverse Characteristics

## Typical Performance Characteristics (Continued)

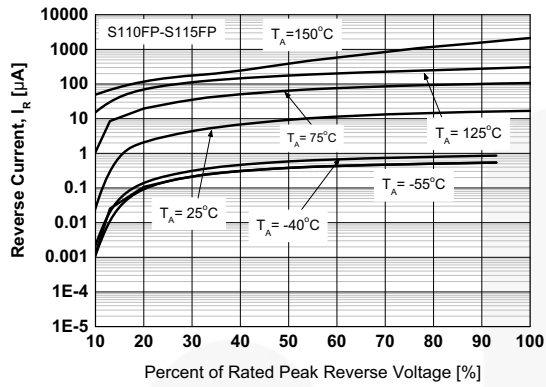


Figure 7. Typical Reverse Characteristics

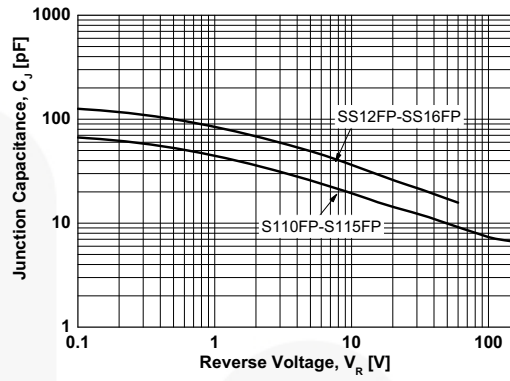
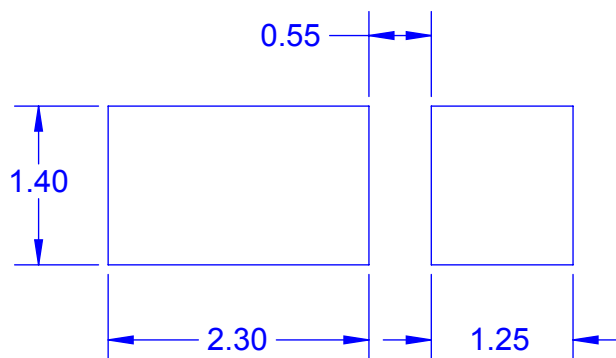
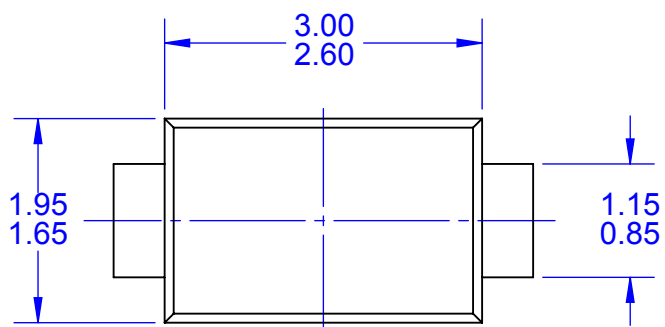
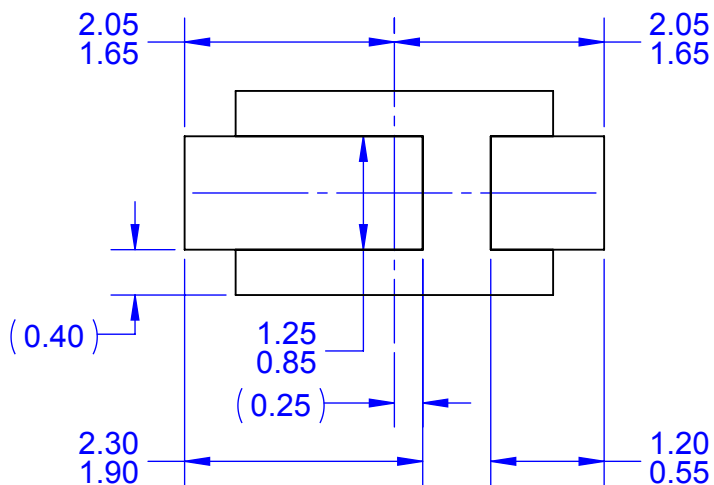
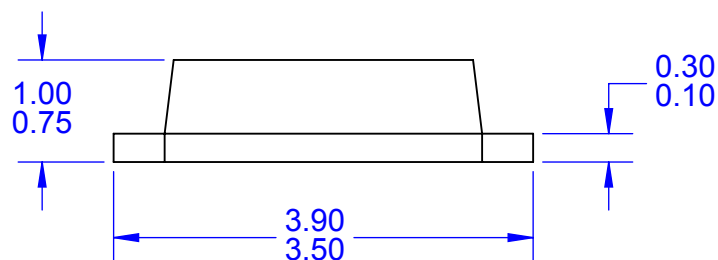


Figure 8. Typical Junction Capacitance



LAND PATTERN RECOMMENDATION



NOTES:

- A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- D. DRAWING FILE NAME: MKT-MA02Crev2



ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada

**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910

**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)

**Order Literature:** <http://www.onsemi.com/orderlit>

For additional information, please contact your local  
Sales Representative

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ON Semiconductor:](#)

[SS14FP](#)



## Данный компонент на территории Российской Федерации

**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9